

HD74LS374

Octal D-type Edge-triggered Flip-Flops (with three-state outputs)

REJ03D0483-0200 Rev.2.00 Feb.18.2005

The HD74LS374, 8-bit register features totem-pole three-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The high-impedance third state and increased high-logic-level drive provide this register with the capability of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pull-up components. They are particularly attractive for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. The eight flip-flops are edge-triggered D-type flip-flops. On the positive transition the clock, the Q outputs will be set to the logic states that ware setup at the D inputs.

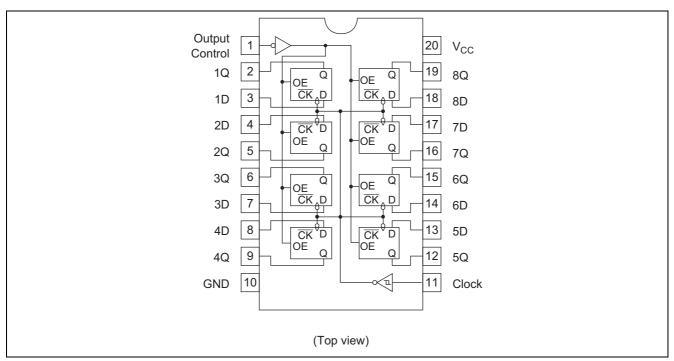
Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS374P	DILP-20 pin	PRDP0020AC-B (DP-20NEV)	Р	_
HD74LS374FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)
HD74LS374RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Function Table

	Outputs		
Output control	Clock	D	Q
L	↑	Н	Н
L	↑	L	L
L	L	X	Q_0
Н	X	X	Z

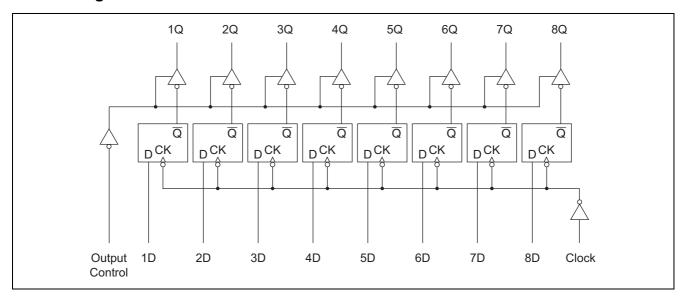
Notes: H; high level, L; low level, X; irrelevant

↑; transition from low to high level

Q₀; level of Q before the indicated steady state input conditions were established

Z; off (high-impedance) state of a three state output

Block Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	
Supply voltage	V _{CC}	7	V	
Input voltage	V _{IN}	7	V	
Power dissipation	P _T	400	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item		Symbol	Min	Тур	Max	Unit
Supply voltage		V _{CC}	4.75	5.00	5.25	V
Output voltage		V _{OH}	_	_	5.5	V
Output current		I _{OH}	_	_	-2.6	mA
		I _{OL}	_	_	24	mA
Operating temperature		Topr	-20	25	75	°C
Clock pulse width "H" Level		t _w	15	_	_	ns
Clock pulse width	"L" Level	t _W	15	_	_	ns
Data setup time		t _{su}	20↑	_	_	ns
Data hold time		t _h	0↑	_	_	ns

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

Item	Symbol	min.	typ.*	max.	Unit	Condition	
Input voltage	V _{IH}	2.0	_	_	V		
Input voltage	V _{IL}	_	_	0.8	V		
Output voltage	V _{OH}	2.4	l		>	$\begin{split} V_{CC} = 4.75 \ V, V_{IH} = 2 \ V, V_{IL} = 0.8 \ V, \\ I_{OH} = -2.6 \ mA \end{split}$	
Output voltage	V			0.4	V	I _{OL} = 12 mA	$V_{CC} = 4.75 \text{ V},$
	V _{OL}			0.5	V	$I_{OL} = 24 \text{ mA}$	$V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V}$
Output current	l _{ozh}			20	^	V _O = 2.7 V	$V_{CC} = 5.25 \text{ V},$
Output current	I _{OZL}			-20	μΑ	V _O = 0.4 V	$V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V}$
	I _{IH}	_	_	20	μΑ	$V_{CC} = 5.25 \text{ V}, V_{I} = 2.7 \text{ V}$	
Input current	I _{IL}	_	_	-0.4	mA	$V_{CC} = 5.25 \text{ V}, V_I = 0.4 \text{ V}$	
	l _l	_	_	0.1	mA	V _{CC} = 5.25 V, V _I = 7 V	
Short-circuit output current	los	-30	_	-130	mA	V _{CC} = 5.25 V	
Supply current	Icc		27	40	mA	$V_{CC} = 5.25 \text{ V},$ $V_{I} = 4.5 \text{ V} \text{ (Output control)}$	
Input clamp voltage	V _{IK}	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$	

Note: $^*V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$

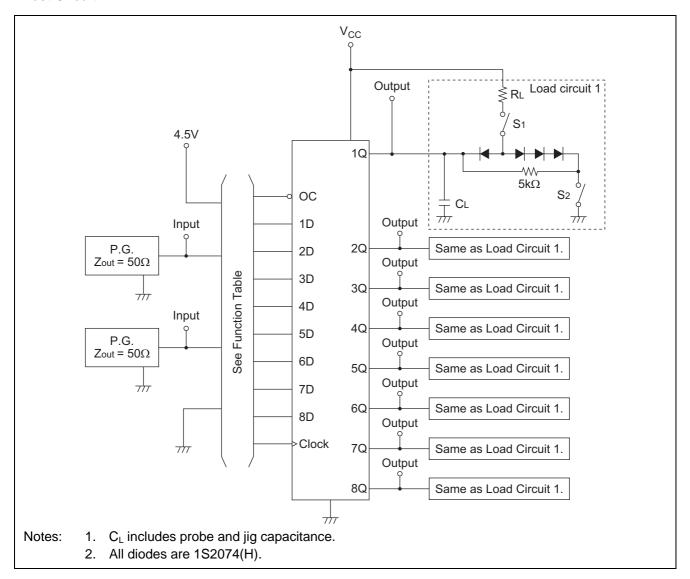
Switching Characteristics

 $(V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C})$

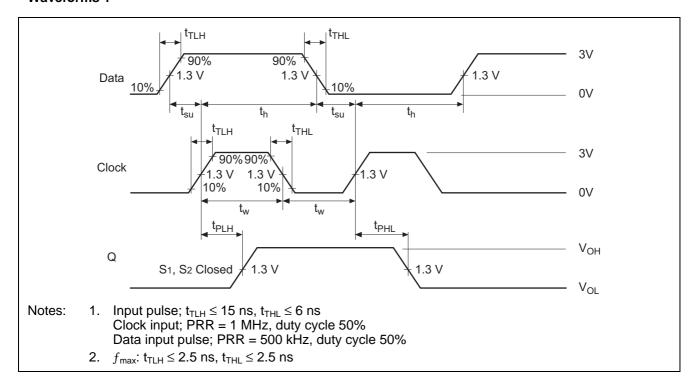
Item	Symbol	Inputs	Output	min.	typ.	max.	Unit	Condition
Maximum clock frequency	$f_{\sf max}$	Clock	Q	35	50		MHz	
Propagation delay time	t_{PLH}	Clock	Q		15	28	ns	$C_L = 45 \text{ pF},$ $R_L = 667 \Omega$
	t_{PHL}	CIOCK			19	28		
Output enable time	t_{ZH}	ОС	Q	_	20	28		
	t_{ZL}	00		_	21	28		
Output disable time	t _{HZ}	ОС	Q	_	12	20		$C_L = 5 \text{ pF},$ $R_L = 667 \Omega$
Output disable tillle	t_LZ	5	Ų	_	14	25		$R_L = 667 \Omega$

Testing Method

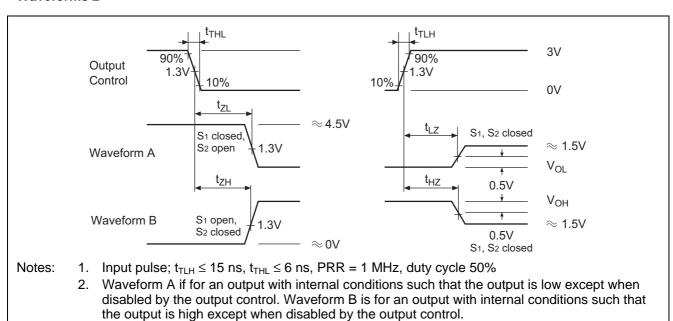
Test Circuit



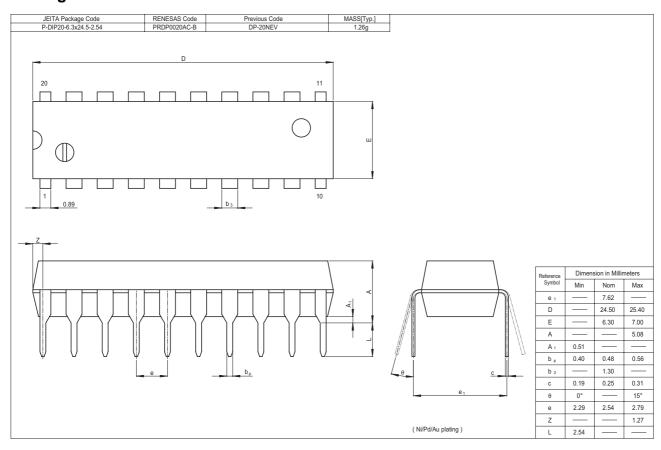
Waveforms 1

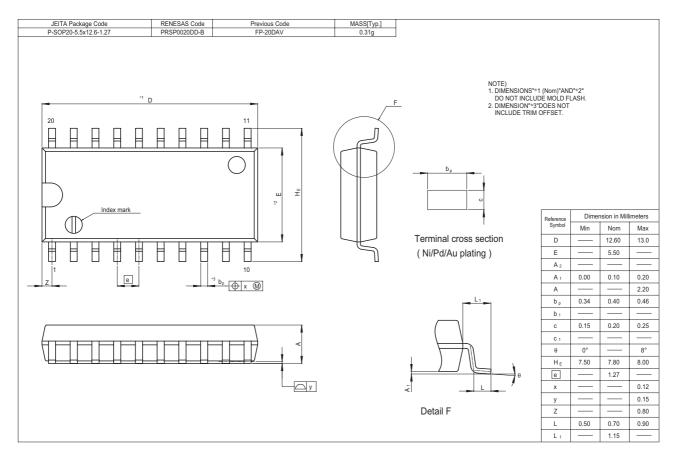


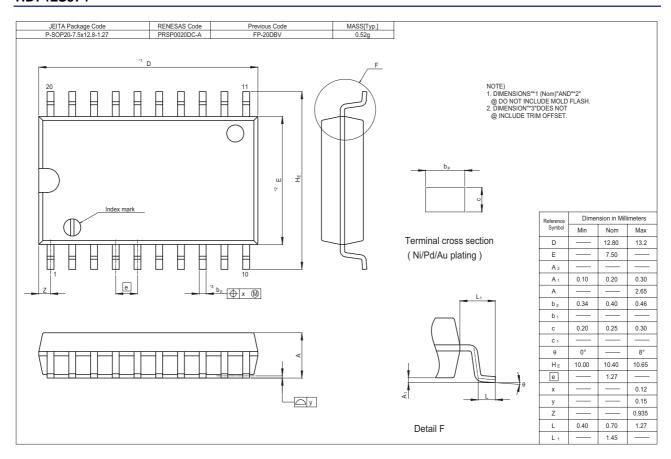
Waveforms 2



Package Dimensions







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